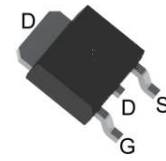
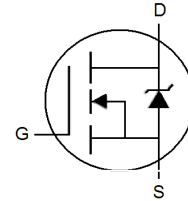


N-CHANNEL Power MOSFET
FEATURES

- V_{DS} : 40V Max., I_D :70A Max
- $R_{DS(ON)}$:9.5m Ω (max.)@ $V_{GS}=10V, I_D=15A$
- High density cell design for ultra low on-resistance
- Fully characterized avalanche voltage and current


TO-252
MECHANICAL DATA

- Case: TO-252
- Case material: Molded Plastic. UL flammability 94V-0
- Weight:0.33grams(approximate)
- Marking:D70N04


EQUIVALENT CIRCUIT
MAXIMUM RATINGS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	40	V
Gate-source voltage	V_{GS}	± 20	V
Continuous drain current	I_D	70	A
Pulsed drain current (Note 1)	I_{DM}	280	A
Power dissipation	P_D	108	W
Thermal resistance from junction to ambient	$R_{\theta JA}$	60	$^\circ\text{C/W}$
Operating junction and storage temperature	T_J, T_{STG}	-55~+150	$^\circ\text{C}$
Single Pulsed Avalanche Energy (note 1)	E_{AS}	66	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10s)	T_L	260	$^\circ\text{C}$

Note: 1. E_{AS} condition: $V_{DD}=20V, L=0.5mH, R_G=25\Omega$, Starting $T_J = 25^\circ\text{C}$

N-CHANNEL Power MOSFET
ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Off characteristics						
Drain-Source breakdown voltage	$V_{(BR)DS}$	40			V	$V_{GS}=0V, I_D=250\mu A$
Zero gate voltage drain current	I_{DSS}			1	μA	$V_{DS}=40V, V_{GS}=0V$
Gate-body leakage current	I_{GSS}			± 100	nA	$V_{DS}=0V, V_{GS}=\pm 20V$
On characteristics (note1)						
Gate-threshold voltage	$V_{GS(th)}$	1.0	1.4	2.0	V	$V_{DS}=V_{GS}, I_D=250\mu A$
Drain-source on-resistance	$R_{DS(on)}$		7.5	9.5	m Ω	$V_{GS}=10V, I_D=15A$
			10	13.5		$V_{GS}=4.5V, I_D=8A$
Forward transconductance	g_{FS}		10		S	$V_{DS}=5V, I_D=70A$
Dynamic characteristics (Guaranteed by design, not subject to production)						
Input capacitance	C_{iss}		4300		pF	$V_{GS}=0V$ $V_{DS}=20V$ $f=1.0MHz$
Output capacitance	C_{oss}		250		pF	
Reverse transfer capacitance	C_{rss}		188		pF	
Switching characteristics (Guaranteed by design, not subject to production)						
Turn-on delay time	$t_{d(on)}$		7		ns	$V_{DD}=20V$ $I_D=20A$ $R_G=3\Omega$ $V_{GS}=10V$
Turn-on rise time	t_r		5		ns	
Turn-off delay time	$t_{d(off)}$		25		ns	
Turn-off fall time	t_f		5		ns	
Total gate charge	Q_g		58		nC	$V_{DS}=20V, V_{GS}=10V,$ $I_D=20A$
Gate-source charge	Q_{gs}		10		nC	
Gate-drain charge	Q_{gd}		10		nC	
Drain-source diode characteristics						
Diode forward voltage	V_{SD}			1.2	V	$I_S=20A, V_{GS}=0V$
Max. forward current	I_S			70	A	
Pulsed drain-source diode forward current	I_{SM}			280	A	

 Notes: 1. Pulse Test: Pulse Width $\leq 300\mu s$, duty cycle $\leq 2\%$.

N-CHANNEL Power MOSFET

TYPICAL CHARACTERISTICS

Figure 1. Output Characteristics

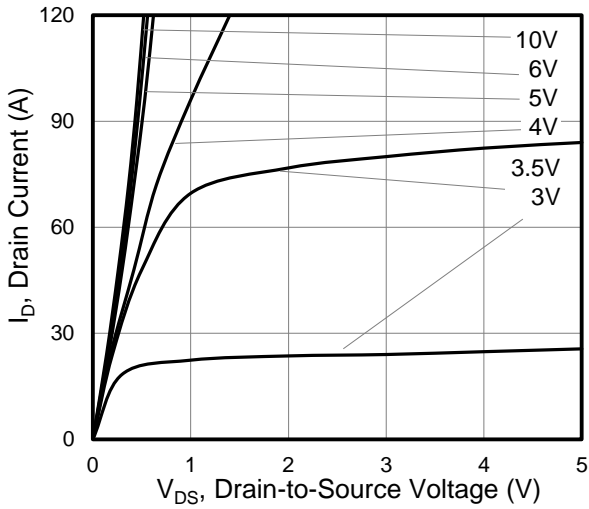


Figure 2. Transfer Characteristics

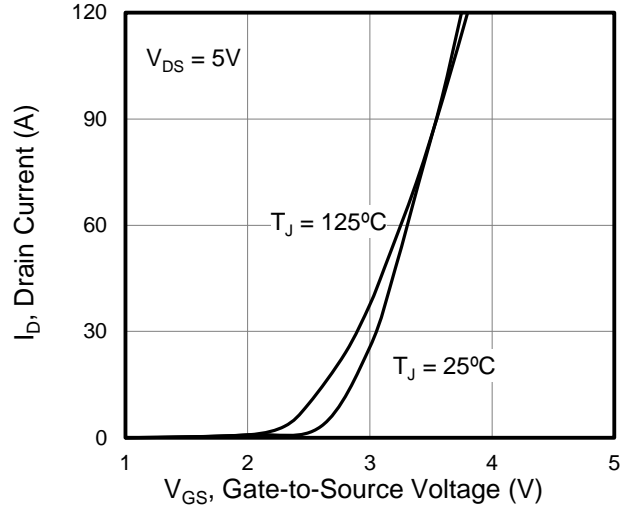


Figure 3. On-Resistance vs. Drain Current

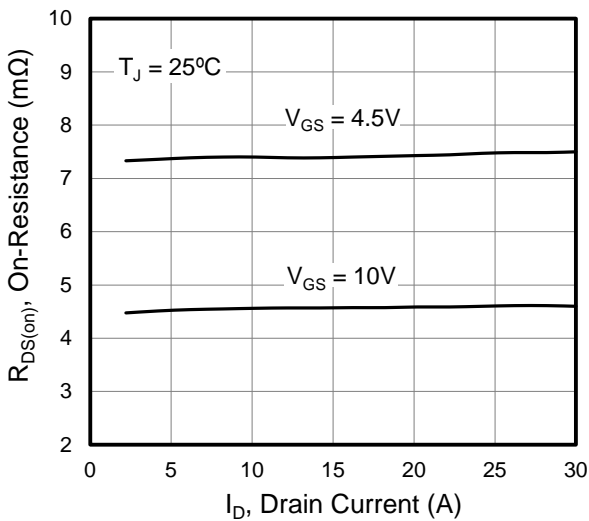


Figure 4. Capacitance

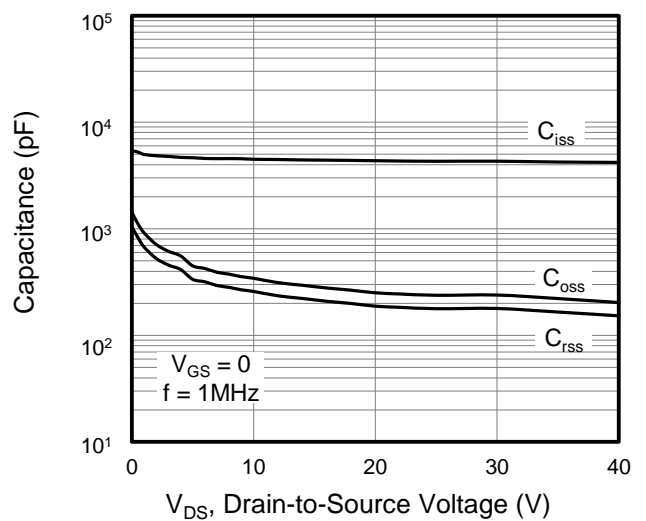


Figure 5. Gate Charge

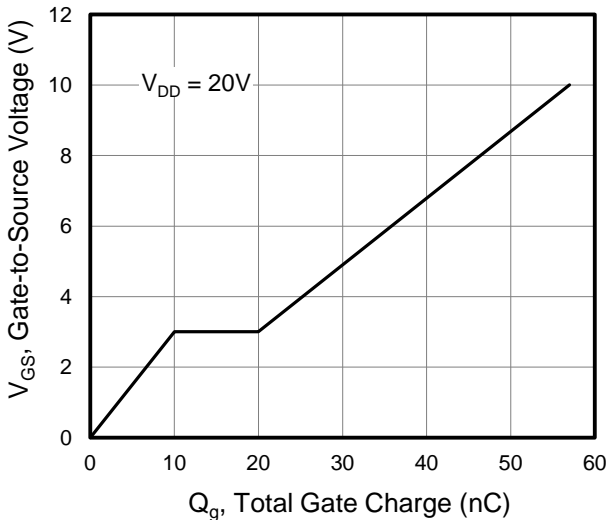
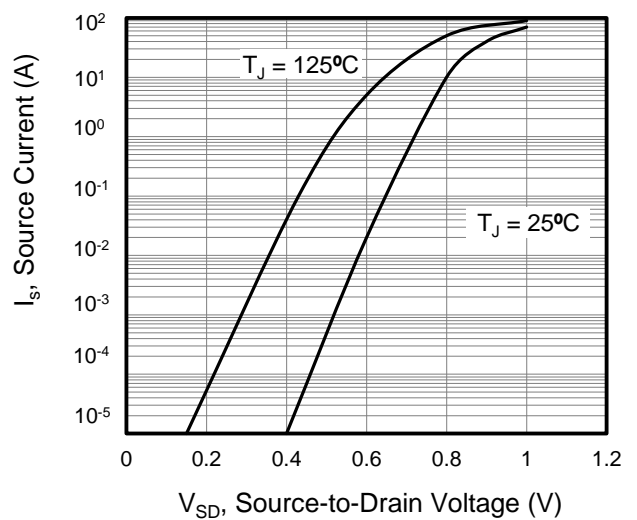
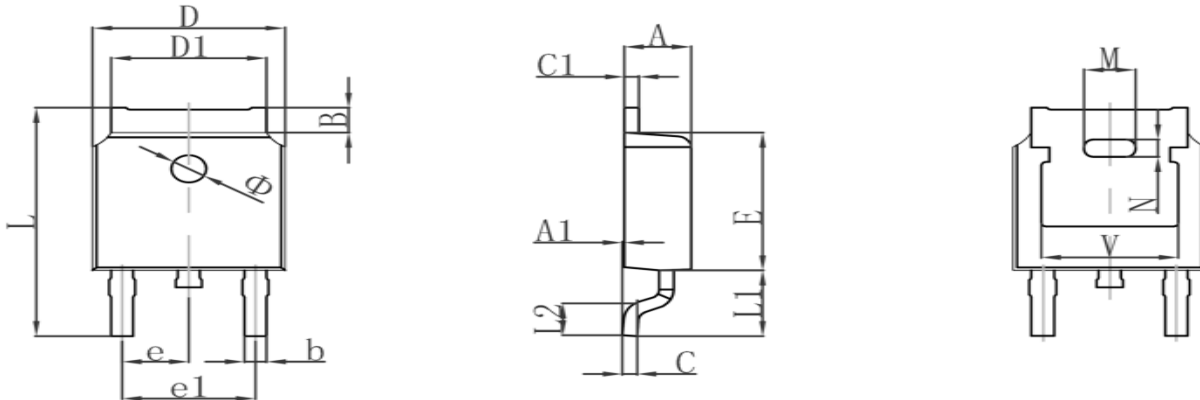


Figure 6. Body Diode Forward Voltage



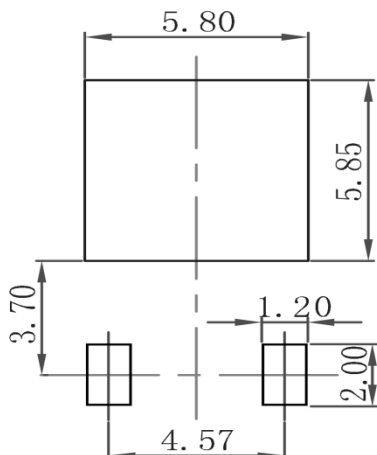
N-CHANNEL Power MOSFET

TO-252 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.380	0.087	0.094
A1	0.000	0.100	0.000	0.004
B	0.800	1.400	0.031	0.055
b	0.710	0.810	0.028	0.032
c	0.460	0.560	0.018	0.022
c1	0.460	0.560	0.018	0.022
D	6.500	6.700	0.256	0.264
D1	5.130	5.460	0.202	0.215
E	6.000	6.200	0.236	0.244
e	2.286TYP		0.090TYP	
e1	4.327	4.727	0.170	0.186
M	1.778REF		0.070REF	
N	0.762REF		0.018REF	
L	9.800	10.400	0.386	0.409
L1	2.9REF		0.114REF	
L2	1.400	1.700	0.055	0.067
V	4.830REF		0.190REF	
Φ	1.100	1.300	0.043	0.051

TO-252 SUGGESTED PAD LAYOUT



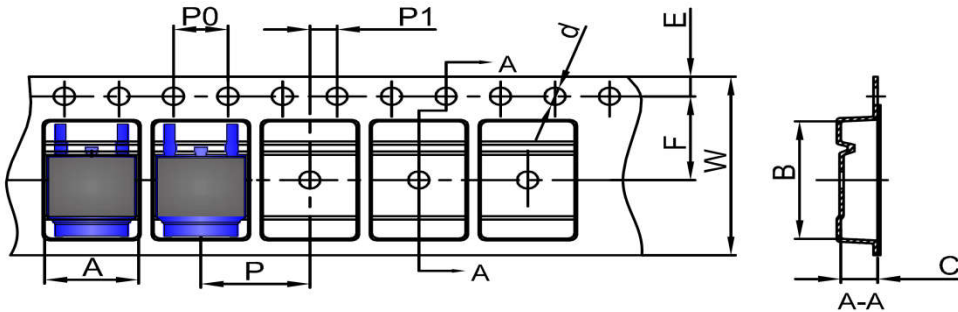
Note:

1. Controlling dimension: in millimeters
2. General tolerance: ±0.05mm
3. The pad layout is for reference purposes only

N-CHANNEL Power MOSFET

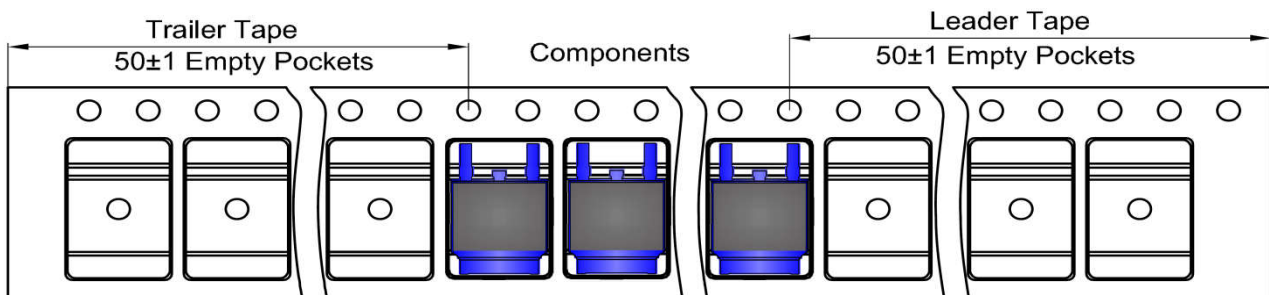
TO-252 TAPE AND REEL

TO-252 Embossed Carrier Tape

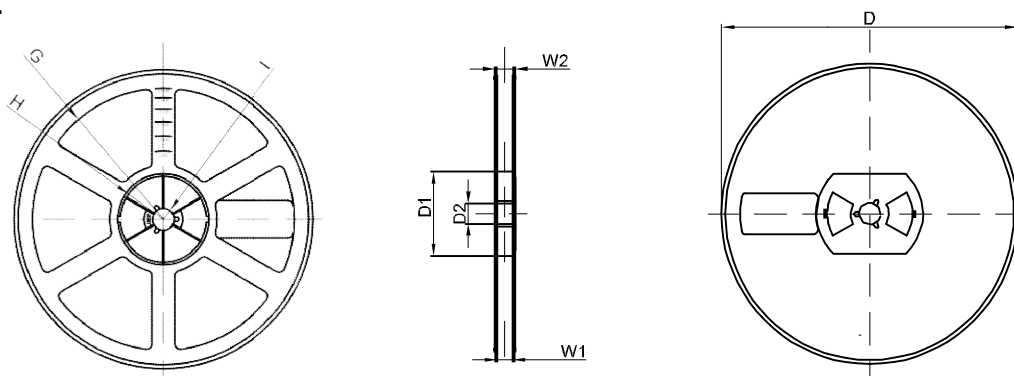


DIMENSIONS ARE IN MILLIMETER										
TYPE	A	B	C	d	E	F	P0	P	P1	W
TO-252	6.90	10.50	2.70	Ø1.55	1.75	7.50	4.00	8.00	2.00	16.00
TOLERANCE	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1

TO-252 Tape Leader and Trailer



TO-252 REEL



DIMENSIONS ARE IN MILLIMETER								
REEL OPTION	D	D1	D2	G	H	I	W1	W2
13" DIA	Ø330.00	100.00	Φ21.00	R151.00	R56.00	R6.50	16.40	21.00
TOLERANCE	±2	±1	±1	±1	±1	±1	±1	±1

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